

Marking Information



SBR20A300CT = Product Type Marking Code AB = Foundry and Assembly Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 14 = 2014) WW = Week (01 - 53)



SBR20A300CTFP = Product Type Marking Code AB = Foundry and Assembly Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 14 = 2014) WW = Week (01 - 53)



SBR20A300CTB= Product Type Marking Code AB = Foundry and Assembly Code YYWW = Date Code Marking YY = Last two digits of year (ex: 08 = 2008) WW = Week (01-52)

Maximum Ratings (Per Leg) (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	300	V
DC Blocking Voltage	V_{RM}		
Average Rectified Output Current (Per Leg) (Total)	Io	10 20	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	180	A
Peak Repetitive Reverse Surge Current (2µS-1Khz)	I _{RRM}	3	Α
Isolation Voltage (ITO-220AB Only) From terminal to heatsink t = 3 sec.	V _{AC}	2,000	V

Thermal Characteristics (Per Leg)

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance (Note 7) Package = TO-220AB Package = ITO-220AB Package = TO263AB (D ² Pak)	R _{eJC}	2 4 2	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to +175	°C

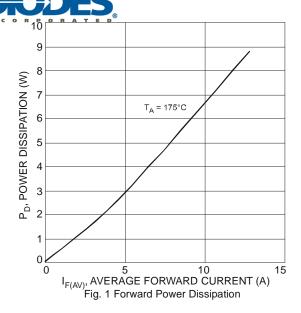
Electrical Characteristics (Per Leg) (@T_A = +25°C, unless otherwise specified.)

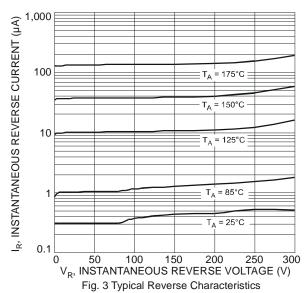
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
		_	_	0.92		$I_F = 10A, T_J = +25$ °C
Forward Voltage Drop	VF	_	0.70	0.78	V	I _F = 10A, T _J = +125°C
		_	_	1.06		$I_F = 20A, T_J = +25$ °C
Leakage Current (Note 6)	1_	_	_	0.1	mA	$V_R = 300V, T_J = +25^{\circ}C$
Leakage Current (Note 0)	IR	_	_	10	IIIA	$V_R = 300V, T_J = +125$ °C
Reverse Recovery Time	T _{rr}	_	45	_	ns	$I_F = 0.5A$, $I_R = 1A$, $I_{RR} = 0.25A$

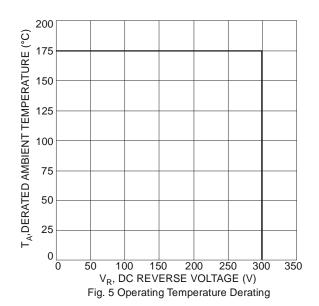
Notes:

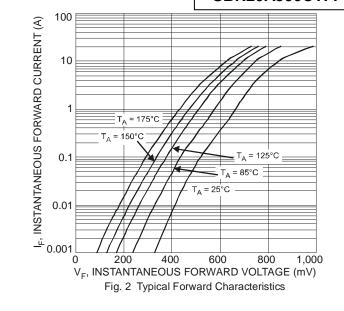
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Using 50mm x 50mm x 23mm Al heatsink.

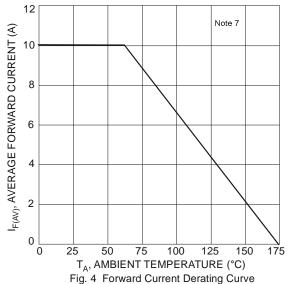
SBR20A300CT SBR20A300CTB SBR20A300CTFP







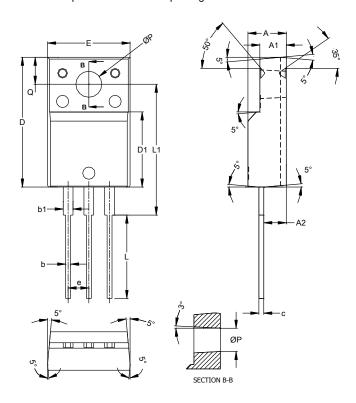




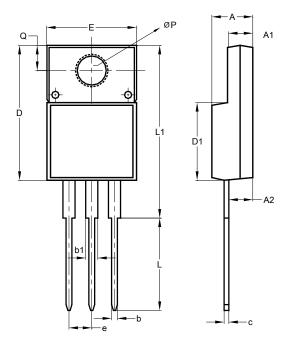


Pāckaģe Oūtline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



ITO220AB				
Dim	Min	Max	Тур	
Α	4.50	4.90	4.70	
A1	3.04	3.44	3.24	
A2	2.56	2.96	2.76	
b	0.50	0.75	0.60	
b1	1.10	1.35	1.20	
С	0.50	0.70	0.60	
D	15.67	16.07	15.87	
D1	8.99	9.39	9.19	
Е	9.91	10.31	10.11	
е			2.54	
L	9.45	10.05	9.75	
L1	15.80	16.20	16.00	
Р	2.98	3.38	3.18	
Q	3.10	3.50	3.30	
All Dimensions in mm				

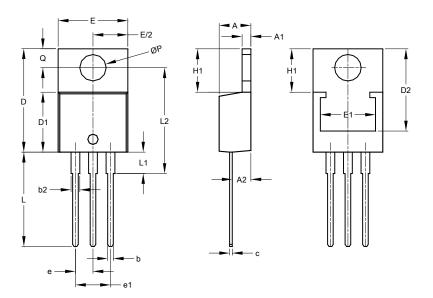


ITO220AB					
	(Type E)				
Dim Min Max					
Α	4.36	4.77			
A1	2.54	3.10			
A2	2.54	2.80			
b	0.55	0.75			
b1	1.20	1.50			
С	0.38	0.68			
D	14.50	15.50			
D1	8.38	8.89			
е	2.41 2.67				
Е	E 9.72 10.27				
L	L 9.87 10.67				
L1	15.8	17.00			
Р	3.08	3.39			
Q	2.60	3.00			
All Dimensions in mm					

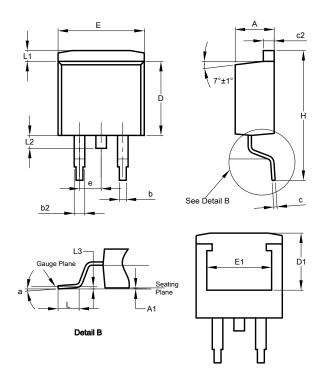


Package Outline Dimensions (Cont.)

Please see http://www.diodes.com/package-outlines.html for the latest version.



TO220AB			
Dim	Min	Max	Тур
Α	3.56	4.82	-
A1	0.51	1.39	-
A2	2.04	2.92	ı
b	0.39	1.01	0.81
b2	1.15	1.77	1.24
C	0.356	0.61	-
D	14.22	16.51	-
D1	8.39	9.01	-
D2	11.45	12.87	1
e	-		2.54
e1	-	-	5.08
Е	9.66	10.66	ı
E1	6.86	8.89	1
H1	5.85	6.85	ı
L	12.70	14.73	-
L1	-	6.35	-
L2	15.80	16.20	16.00
Р	3.54	4.08	-
ø	2.54	3.42	-
All Dimensions in mm			

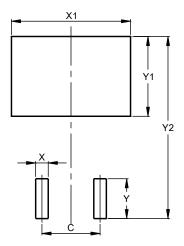


TO263AB (D2PAK)			
Dim	Min	Max	Тур
Α	4.07	4.82	-
A1	0.00	0.25	1
b	0.51	0.99	-
b2	1.15	1.77	1
С	0.356	0.73	-
c2	1.143	1.65	-
D	8.39	9.65	-
D1	6.55	6.95	-
е	2.54 TYP		
Е	9.66	10.66	-
E1	6.23	8.23	1
Н	14.61	15.87	-
L	1.78	2.79	-
L1	-	1.67	-
L2	-	1.77	-
L3	-	-	0.254
а	0°	8°	-
All Dimensions in mm			



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	5.08
Х	1.10
X1	10.41
Υ	3.50
Y1	7.01
Y2	15.99

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